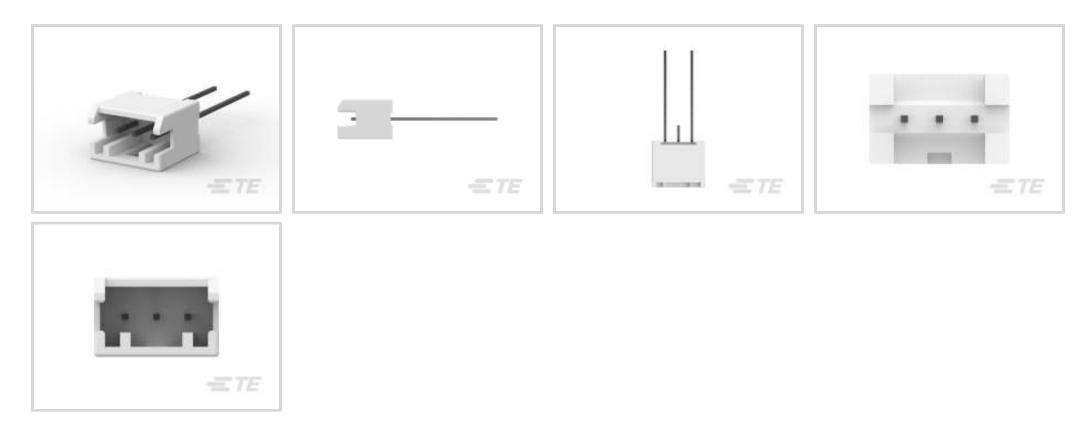
5-1376492-3 <

AMP Signal Double Lock

TE Internal #: 5-1376492-3 PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [. 098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, AMP Signal Double Lock

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 3

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]

PCB Mount Orientation: Vertical

Features



Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	3
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	50 VAC
Body Features	
Primary Product Color	Natural

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, AMP Signal Double Lock



Contact Features

Mating Square Post Dimension	.5 mm[.02 in]
PCB Contact Termination Area Plating Material Thickness	.8 – 1.6 μm[31.49 – 62.99 μin]
Contact Layout	Inline
Contact Underplating Material Thickness	.5 – 1.2 μm[19.68 – 47.24 μin]
Contact Mating Area Plating Material Thickness	.8 μm[31.49 μin]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Matte
Contact Underplating Material	Copper
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	2.5 A
Termination Features	
Square Termination Post & Tail Dimension	.5 mm[.02 in]
Termination Post & Tail Length	2.8 mm, 16.8 mm[.11 in][.661 in]

Termination	Method to	Printed	Circuit Board

Through Hole - Solder

Mechanical Attachment

Mating Alignment Type	Polarization
Mating Retention	With
Mating Retention Type	Latch
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without
Housing Features	
Housing Material	Nylon 66 GF
Centerline (Pitch)	2.5 mm[.098 in]
Dimensions	
Connector Length	10 mm[.39 in]

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, AMP Signal Double Lock



Connector Height	8.6 mm[.34 in]
Connector Width	8.2 mm[.32 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Usage Conditions	
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]
Operation/Application	
Circuit Application	Signal
Packaging Features	
Packaging Quantity	900
Packaging Type	Таре
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235)

Candidate List Declared Against: JUL 2021 (219) Does not contain REACH SVHC

Not Low Halogen - contains Br or Cl > 900 ppm.

Solder Process Capability

Halogen Content

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, AMP Signal Double Lock





TE Part # 1376477-3 2.5MM PITCH SIGNAL MATE CONN



Also in the Series AMP Signal Double Lock



Rectangular Caps & Covers(1)	Rectangular Connector Housings(23)	Rectangular Connector Locking(2)	Rectangular Connector Seals(10)
			AND AND
Rectangular Power Connectors(3)	Standard Rectangular Connectors(1)	Wire-to-Board Connector Assemblies & Housings(76)	Wire-to-Board Connector Contacts(6)

Customers Also Bought



PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, AMP Signal Double Lock





Documents

Product Drawings 2.5MM SIGNAL MATE CONN ON TAPE

English

CAD Files

Customer View Model ENG_CVM_CVM_5-1376492-3_G.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5-1376492-3_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5-1376492-3_G.3d_stp.zip

English

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Product Specifications Application Specification

English

Product Environmental Compliance

TE Material Declaration

English